TOSHIBA HN3C16FT

TENTATIVE

TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

HN3C16FT

VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

TWO devices are built in to the super-thin and ultra super mini (6pins) package: TU6

MOUNTED DEVICES

	Q1 / Q2
Three-pins (SSM) mold products are	2SC5261
corresponded	2505201

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V _{CBO}	15	V
Collector-Emitter Voltage	VCEO	7	V
Emitter-Base Voltage	$V_{ m EBO}$	1.5	V
Collector Current	$I_{\mathbf{C}}$	15	mA
Base Current	I_{B}	7	mA
Collector Power Dissipation	PC	200	mW
Junction Temperature	T_{j}	125	°C
Storage Temperature Range	$T_{ m stg}$	-55~125	°C

Unit in mm 2.1 ± 0.1 1.25 ± 0.1 0.65 1.3 ± 0.1 0~0 1. COLLECTOR 1 4. EMITTER 2 2. EMITTER 1 5. BASE 2 3. COLLECTOR 2 6. BASE 1 JEDEC

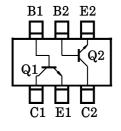
2-2J1A

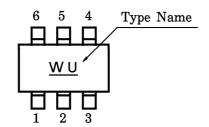
Weight: 0.008g

EIAJ TOSHIBA

PIN ASSIGNMENT (TOP VIEW)

MARKING





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ELECTRICAL CHARACTERISTICS (Q1, Q2) (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	ICBO	$V_{CB} = 10V, I_{E} = 0$	_	_	1	μ A
Emitter Cut-off Current	I_{EBO}	$V_{EB}=1V, I_{C}=0$	_	_	1	μ A
DC Current Gain	$_{ m h_{FE}}$	$V_{CE}=5V, I_{C}=7mA$	50	_	160	_
Transition Frequency	$\mathbf{f_T}$	$V_{CE}=5V, I_{C}=7mA$	9	12	_	GHz
Insertion Gain	$ S_{21e} ^2$	V _{CE} =5V, I _C =7mA, f=2000MHz	_	10.5	_	dB
Noise Figure	NF	V _{CE} =5V, I _C =3mA, f=2000MHz	_	1.7	3	dB
Reverse Transfer Capacitance Q1	c_{re}	$V_{\mathrm{CB}} = 5\mathrm{V}, \ \mathrm{I_E} = 0, \ \mathrm{f} = 1\mathrm{MHz} \ \mathrm{(Note)}$	_	0.45	0.85	, F
Reverse Transfer Capacitance Q2	$\mathrm{C_{re}}$		_	0.4	0.8	pF

(Note) C_{re} is measured by 3 terminal method capacitance bridge.